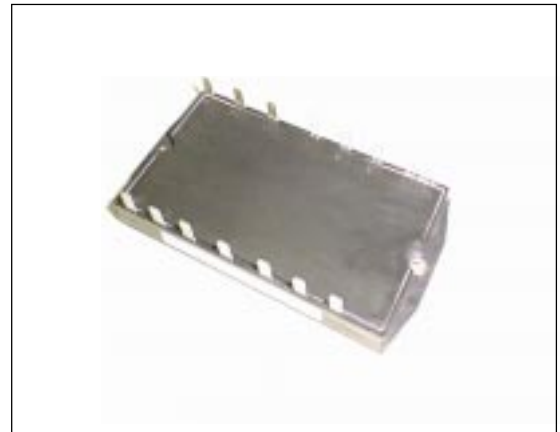


IGBT MODULE

1200V / 25A / PIM



■ Features

- High Speed Switching
- Voltage Drive
- Low Inductance Module Structure
- Converter Diode Bridge Dynamic Brake Circuit

■ Applications

- Inverter for Motoe Drive
- AC and DC Servo Drive Amplifier
- Uninterruptible Power Supply

■ Maximum ratings and characteristics

● Absolute maximum ratings (Tc=25°C unless without specified)

Item	Symbol	Condition	Rating	Unit	
Inverter	Collector-Emitter voltage	V _{CES}	1200	V	
	Gate-Emitter voltage	V _{GES}	±20	V	
	Collector current	I _C	Continuous	25	A
		I _{CP}	1ms	50	A
		-I _C		25	A
Collector power dissipation	P _C	1 device	200	W	
Brake	Collector-Emitter voltage	V _{CES}	1200	V	
	Gate-Emitter voltage	V _{GES}	±20	V	
	Collector current	I _C	Continuous	15	A
		I _{CP}	1ms	30	A
	Collector power dissipation	P _C	1 device	120	W
	Repetitive peak reverse voltage			1200	V
	Average forward current	I _{F(AV)}		1	A
Surge current	I _{FSM}	10ms	50	A	
Converter	Repetitive peak reverse voltage	V _{R_{RM}}	1600	V	
	Non-Repetitive peak reverse voltage	V _{R_{SM}}	1700	V	
	Average output current	I _O	50Hz/60Hz sine wave	25	A
	Surge current (Non-Repetitive)	I _{FSM}	T _j =150°C, 10ms	320	A
	I ² t (Non-Repetitive)		T _j =150°C, 10ms	512	A ² s
Operating junction temperature	T _j		+150	°C	
Storage temperature	T _{stg}		-40 to +125	°C	
Isolation voltage	V _{iso}	AC : 1 minute	AC 2500	V	
Mounting screw torque			1.7 * ₁	N·m	

*₁ Recommendable value : 1.3 to 1.7 N·m (M4)

● Electrical characteristics (Tj=25°C unless without specified)

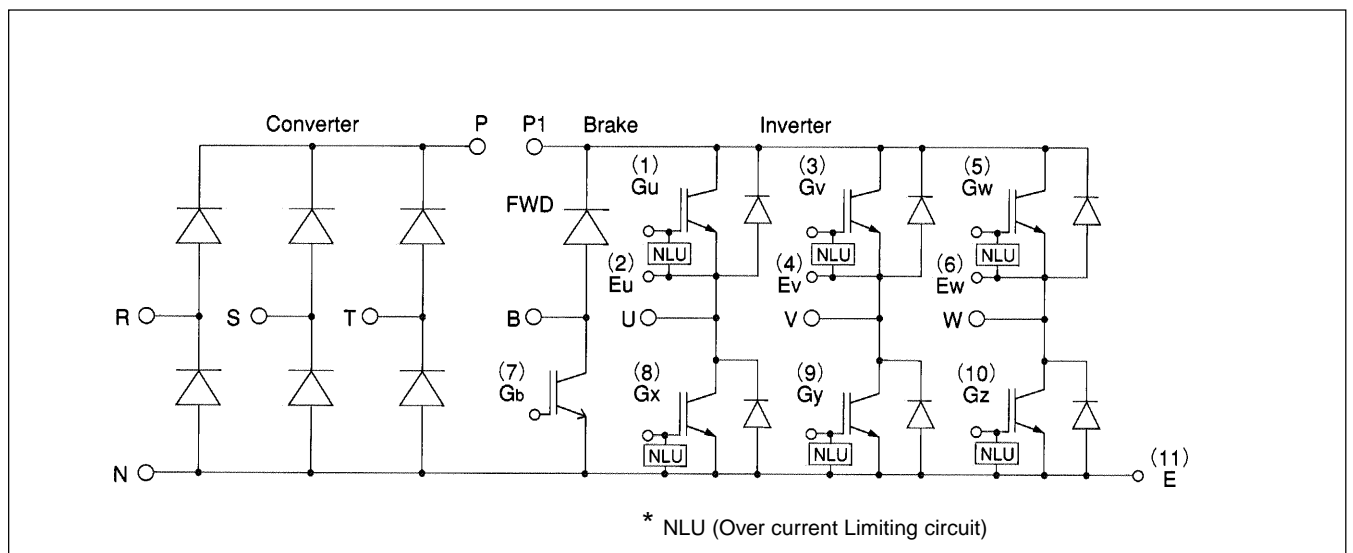
Item	Symbol	Condition	Characteristics			Unit		
			Min.	Typ.	Max.			
Inverter (IGBT)	Zero gate voltage collector current	ICES	VCE=1200V, VGE=0V			1.0	mA	
	Gate-Emitter leakage current	IGES	VCE=0V, VGE=±20V			20	µA	
	Gate-Emitter threshold voltage	VGE(th)	VCE=20V, IC=25mA			4.5	V	
	Collector-Emitter saturation voltage	VCE(sat)	VGE=15V, IC=25A			3.3	V	
	Collector-Emitter voltage	-VCE	-IC=25A			3.0	V	
	Input capacitance	Cies	VGE=0V, VCE=10V, f=1MHz			4000	pF	
	Switching time	ton	VCC=600V				1.2	µs
tr		IC=25A				0.6	µs	
toff		VGE=±15V				1.5	µs	
tf		RG=51 ohm				0.5	µs	
Reverse recovery time of FRD	trr	IF=25A				0.35	µs	
Brake (IGBT)	Zero gate voltage collector current	ICES	VCE=1200V, VGE=0V			1.0	mA	
	Gate-Emitter leakage current	IGES	VCE=0V, VGE=±20V			0.1	µA	
	Collector-Emitter saturation voltage	VCE(sat)	IC=15A, VGE=15V			3.3	V	
	Switching time	ton	VCC=600V				0.8	µs
		tr	IC=15A				0.6	µs
toff		VGE=±15V				1.5	µs	
tf		RG=82 ohm				0.5	µs	
Brake (FWD)	Reverse current	IRRM	VR=1200V			1	mA	
	Reverse recovery time	trr				0.6	µs	
Converter	Forward voltage	VFM	IF=25A			1.4	V	
	Reverse current	IRRM	VR=1600V			1.0	mA	

● Thermal Characteristics

Item	Symbol	Condition	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance (1 device)	Rth(j-c)	Inverter IGBT			0.63	°C/W
		Inverter FRD			1.70	
		Brake IGBT			1.04	
		Converter Diode			3.40	
Contact thermal resistance *	Rth(c-f)	With thermal compound		0.05		

* This is the value which is defined mounting on the additional cooling fin with thermal compound

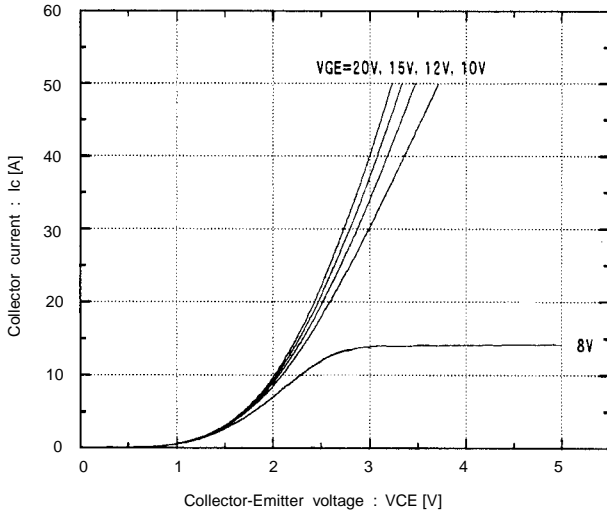
■ Equivalent Circuit Schematic



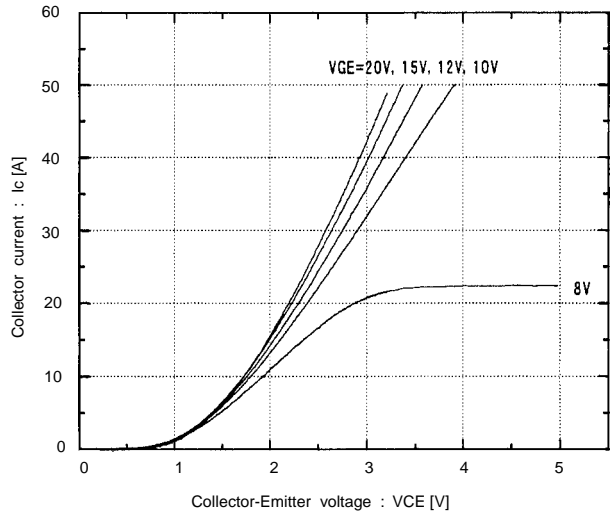
Characteristics (Representative)

Inverter

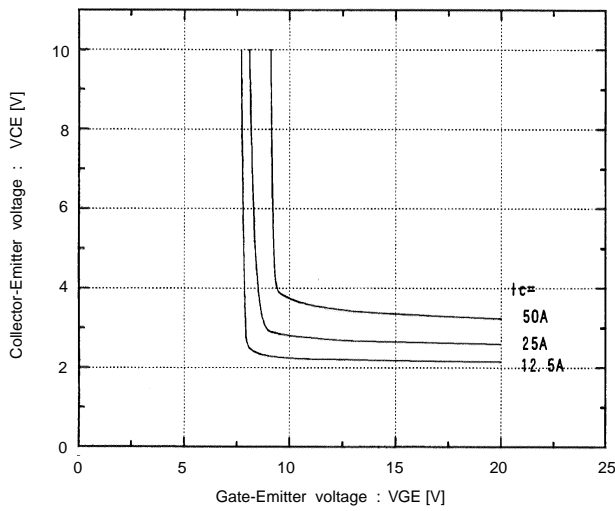
Collector current vs. Collector-Emitter voltage
T_J=25°C



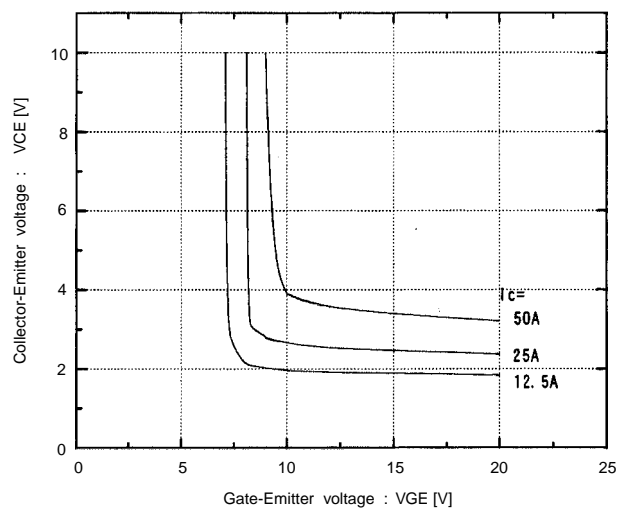
Collector current vs. Collector-Emitter voltage
T_J=125°C



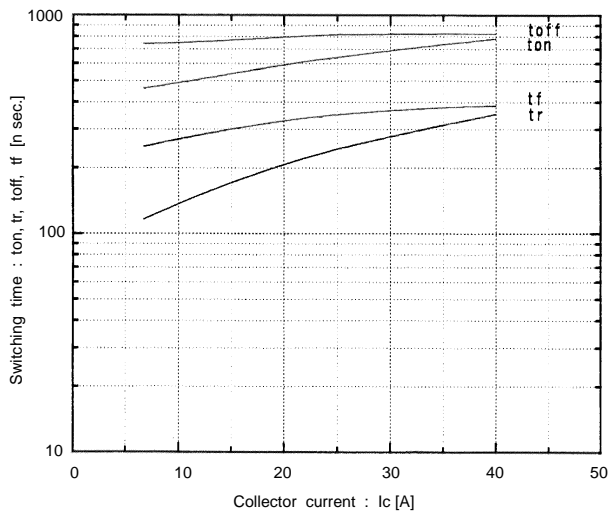
Collector-Emitter vs. Gate-Emitter voltage
T_J=25°C



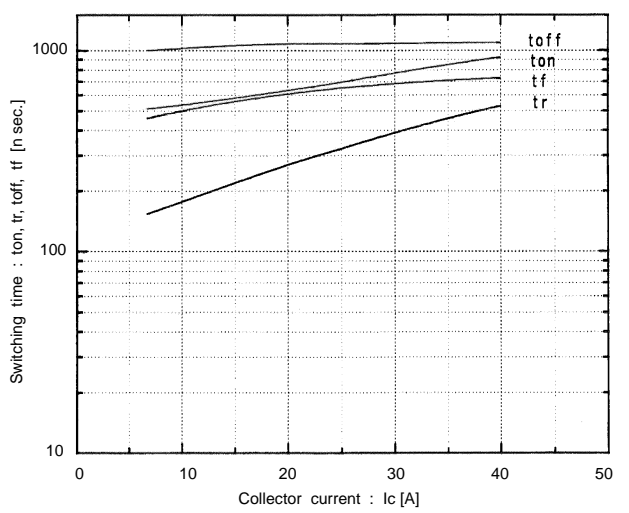
Collector-Emitter vs. Gate-Emitter voltage
T_J=125°C



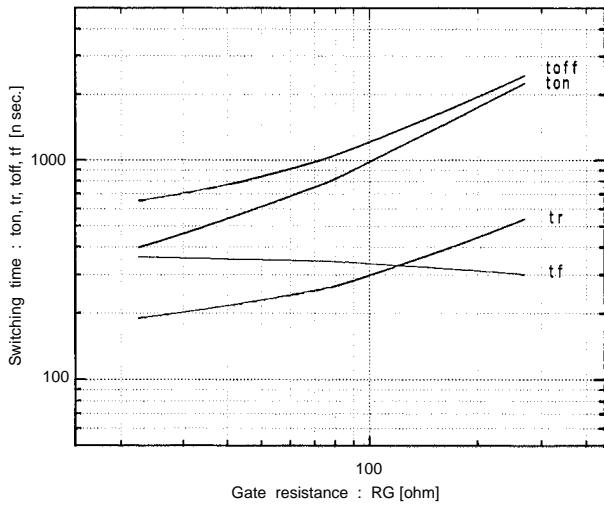
Switching time vs. Collector current
V_{CC}=600V, R_G=51 ohm, V_{GE}=±15V, T_J=25°C



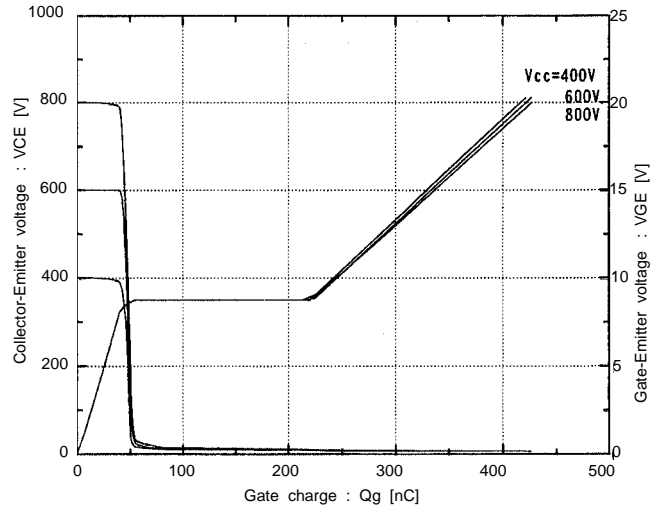
Switching time vs. Collector current
V_{CC}=600V, R_G=51 ohm, V_{GE}=±15V, T_J=125°C



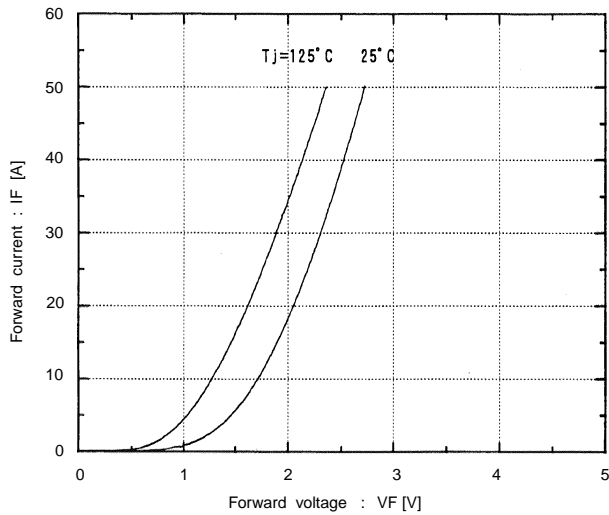
Switching time vs. R_G
 $V_{CC}=600V, I_C=25A, V_{GE}=\pm 15V, T_J=25^\circ C$



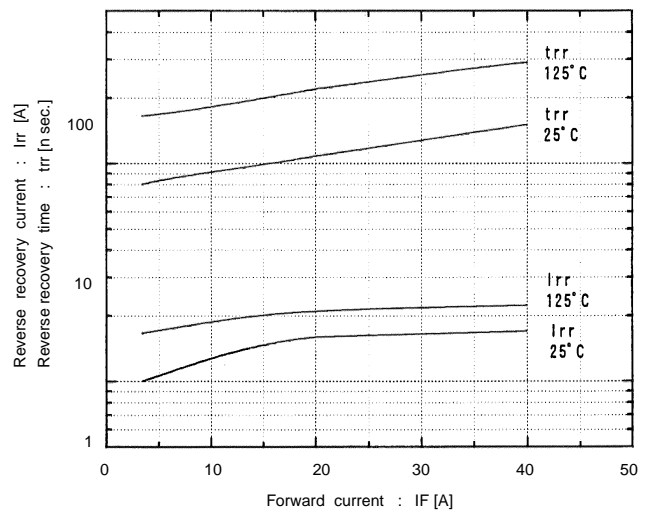
Dynamic input characteristics
 $T_J=25^\circ C$



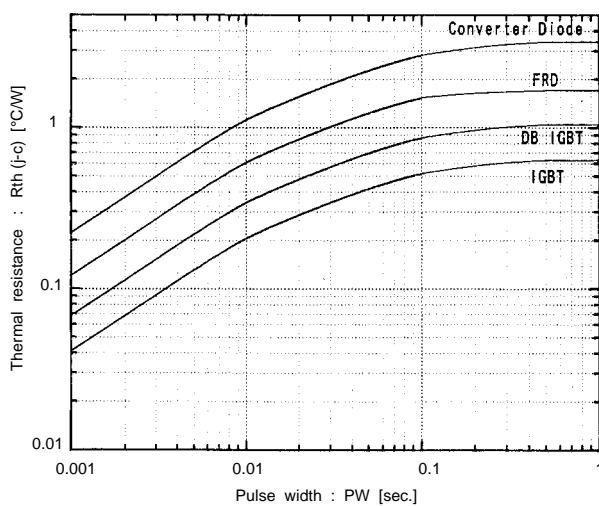
Forward current vs. Forward voltage
 $V_{GE}=0V$



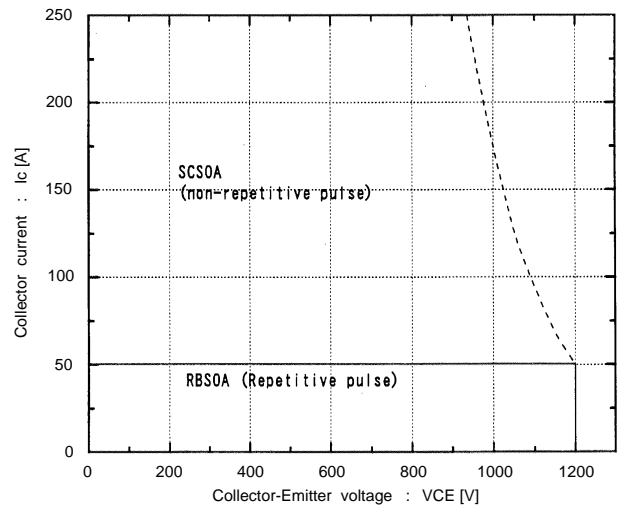
Reverse recovery characteristics
 t_{rr}, I_{rr} vs. I_F



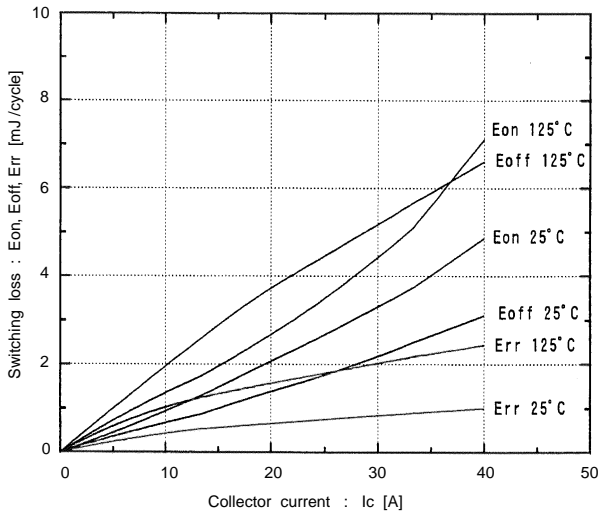
Transient thermal resistance



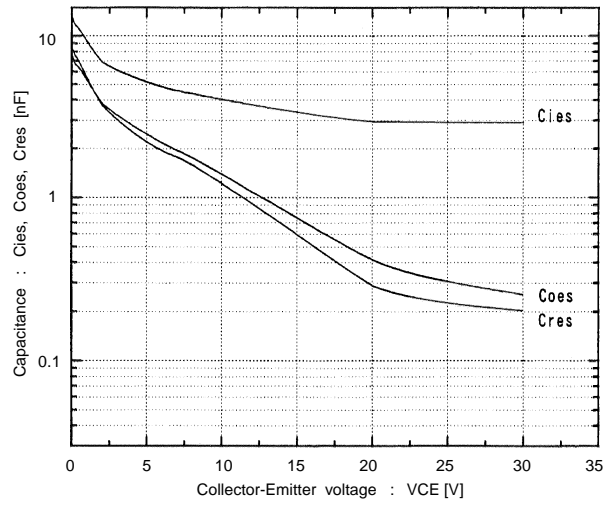
Reversed biased safe operating area
 $+V_{GE}=15V, -V_{GE} \leq 15V, T_J \leq 125^\circ C, R_G \geq 51 \text{ ohm}$



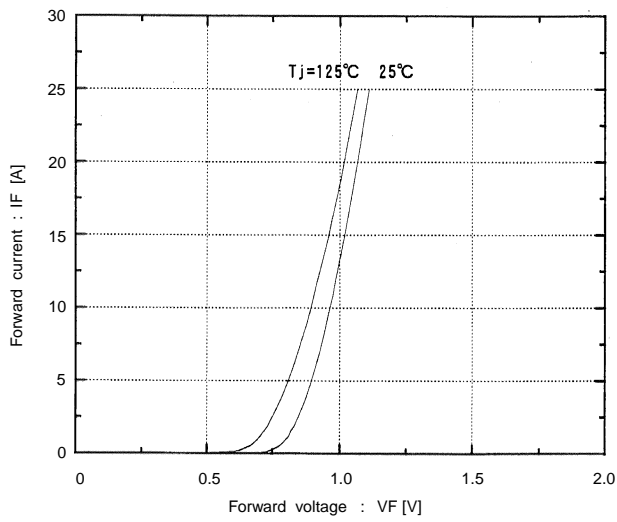
Switching loss vs. Collector current
 $V_{cc}=600V, R_G=51\text{ ohm}, V_{GE}=\pm 15V$



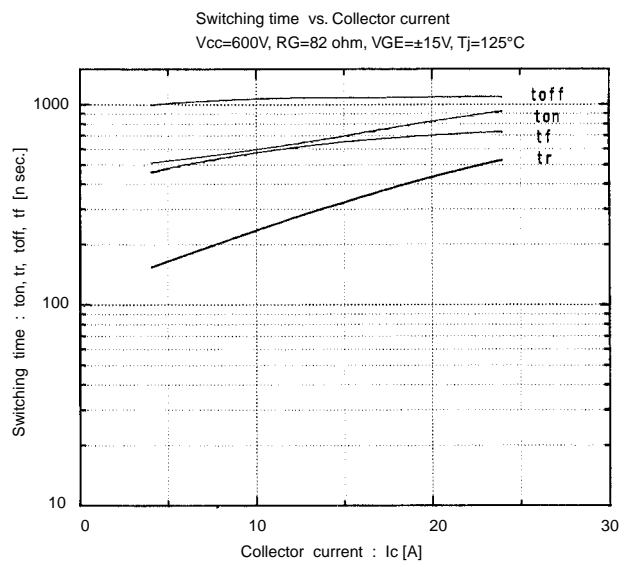
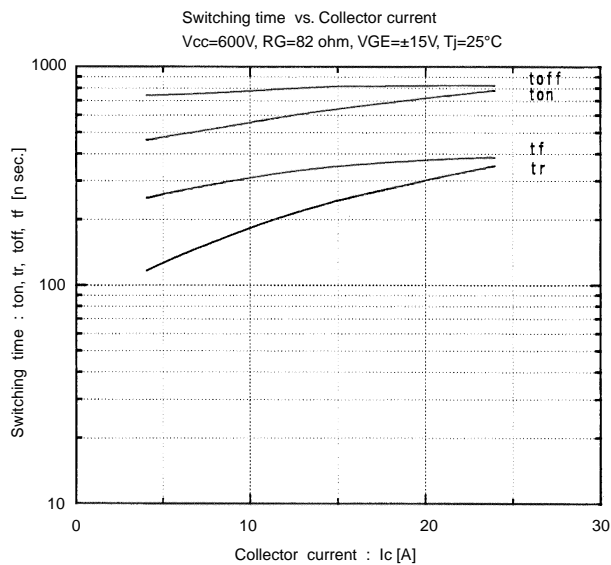
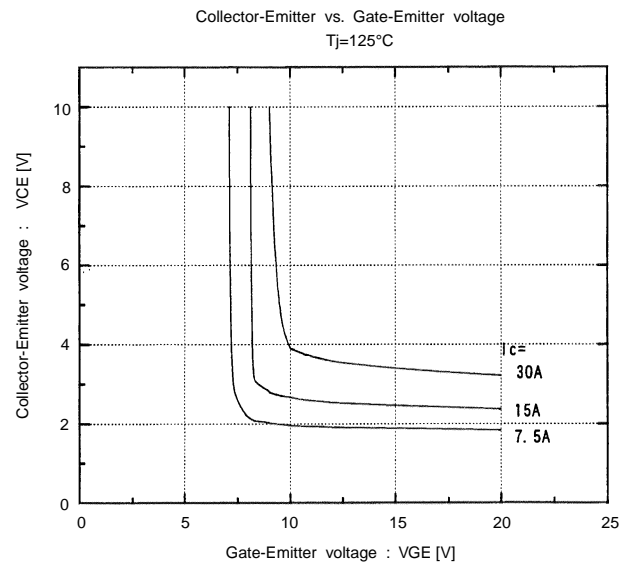
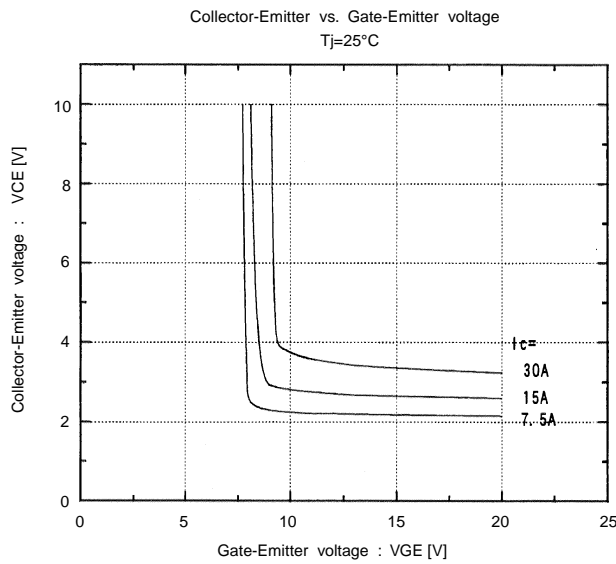
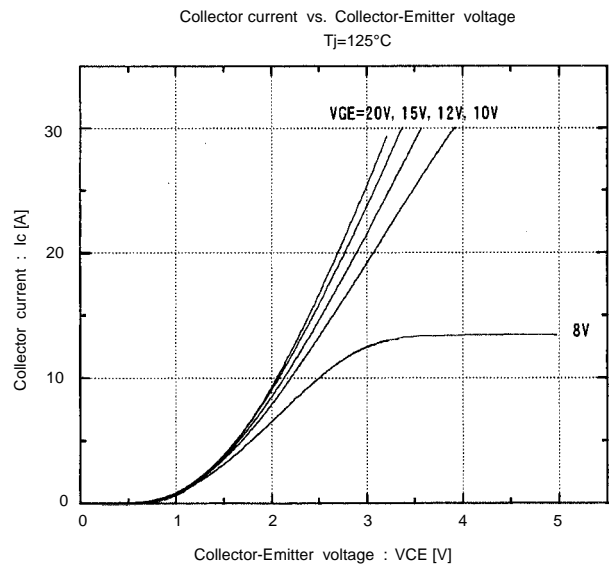
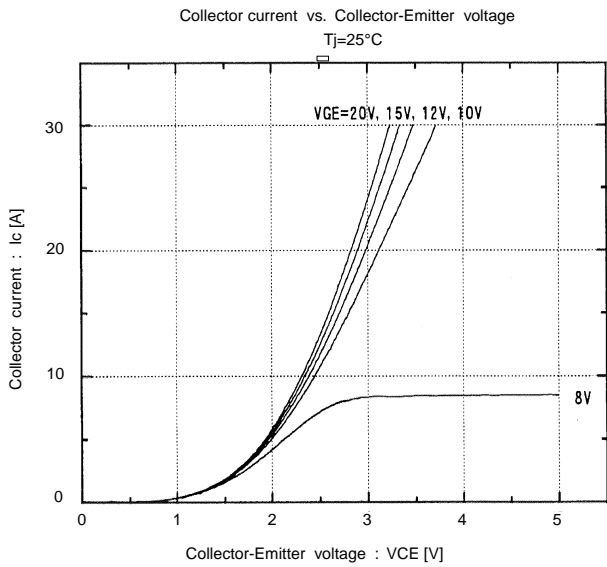
Capacitance vs. Collector-Emitter voltage
 $T_j=25^\circ\text{C}$



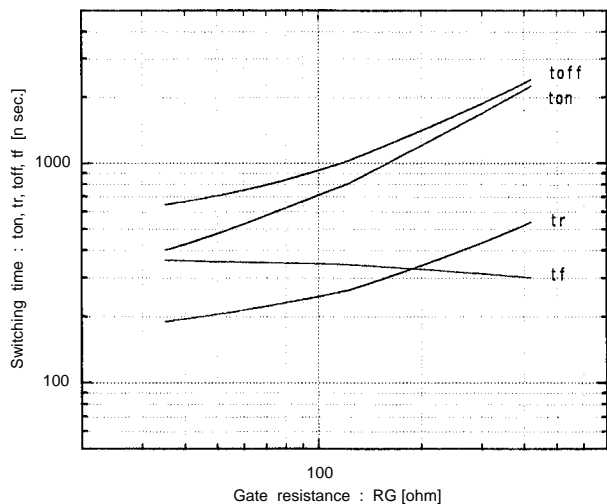
Converter Diode
 Forward current vs. Forward voltage



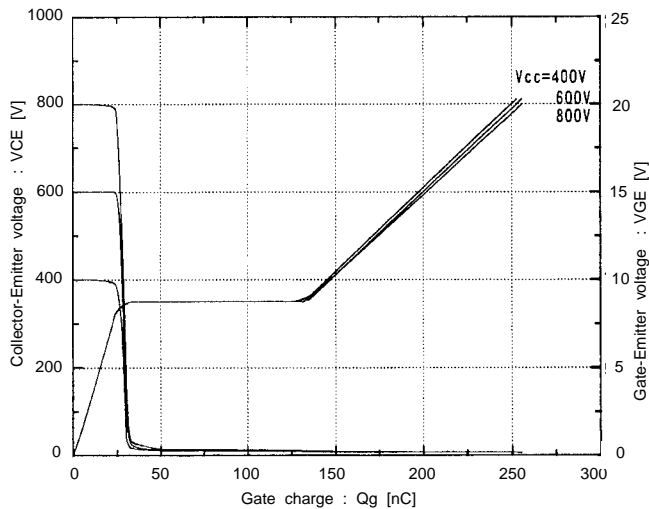
● Brake



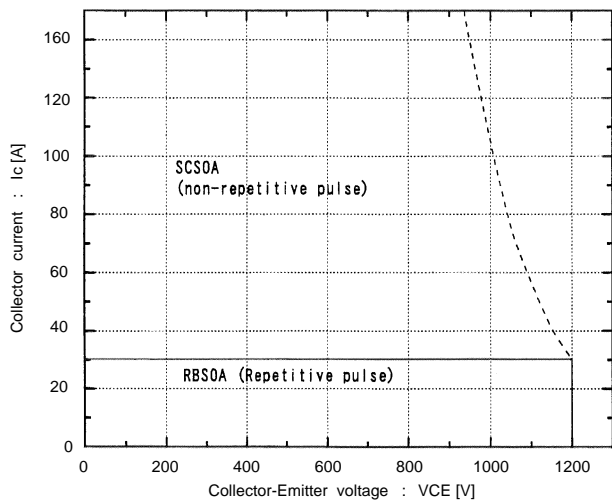
Switching time vs. RG
 $V_{cc}=600V, I_c=15A, V_{GE}=\pm 15V, T_j=25^\circ C$



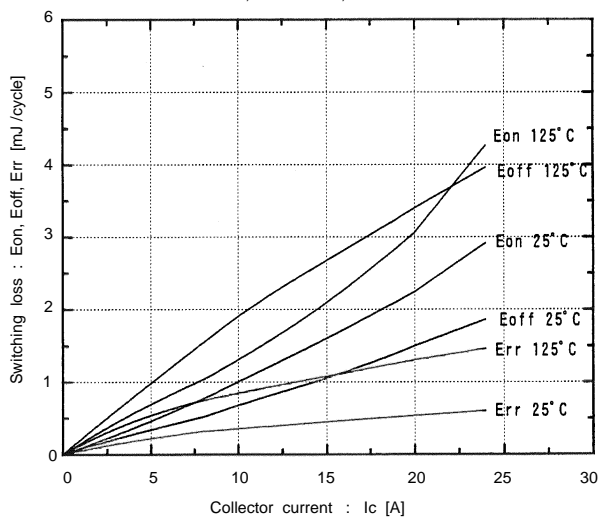
Dynamic input characteristics
 $T_j=25^\circ C$



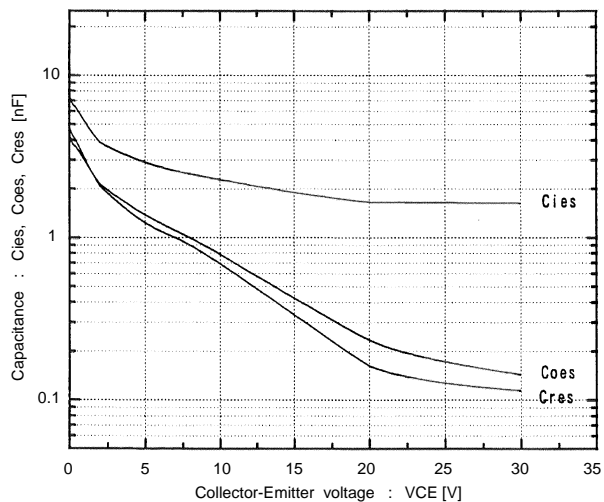
Reversed biased safe operating area
 $+V_{GE}=15V, -V_{GE} \le 15V, T_j \le 125^\circ C, R_G \ge 82 \text{ ohm}$



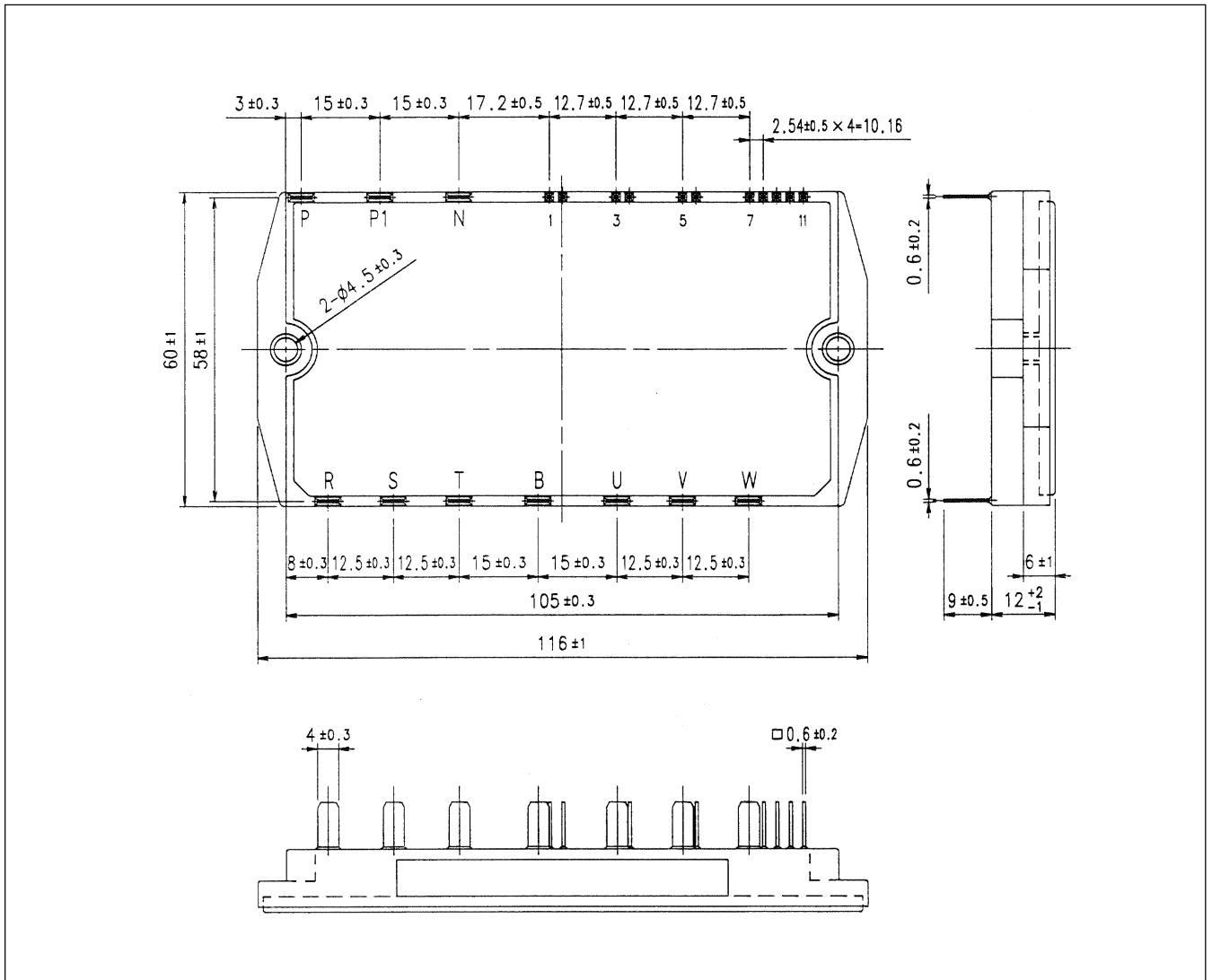
Switching loss vs. Collector current
 $V_{cc}=600V, R_G=82 \text{ ohm}, V_{GE}=\pm 15V$



Capacitance vs. Collector-Emitter voltage
 $T_j=25^\circ C$



■ Outline Drawings, mm



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